

To make it possible to obtain a sharp impurity profile without presenting a disadvantage such as an increase in parasitic resistance or the like using a laser annealing method to thereby meet sufficiently the requirements for making a semiconductor element finer and more highly integrated. A gate electrode is pattern formed above a semiconductor substrate made of n-type silicon single crystal through a gate Thereafter, atoms, Ge+ here, having insulating film. properties just enough to amorphize single crystal Si are ion implanted (shown by arrows) from oblique directions to the Si surface of the substrate with the gate electrode as a mask to melt and recrystallize the single crystal Si so as to form amorphous regions which seep into the substrate under Thereafter B⁺ ions are implanted the gate electrode. into the amorphous regions and laser irradiation is executed thereon.